



**15.6 inch TFT LCD
without Touch Panel
SPECIFICATION**

MODEL NAME: LMTBC156ZMN1

Date: 2015 / 06 / 12

Customer Signature		
Customer		
Approved Date	Approved By	Reviewed By

Contents

1. Handling Precautions	4
2. General Description	5
2.1 General Specification	5
2.2 Optical Characteristics	6
3. Functional Block Diagram	9
4. Absolute Maximum Ratings	10
4.1 Absolute Ratings of TFT LCD Module	10
4.2 Absolute Ratings of Environment	10
5. Electrical Characteristics	11
5.1 TFT LCD Module	11
5.2 Backlight Unit	14
6. Signal Interface Characteristic	15
6.1 Pixel Format Image	15
6.2 Integration Interface Requirement	16
6.3 Interface Timing	18
6.4 Power ON/OFF Sequence	19
7. Panel Reliability Test	23
7.1 Vibration Test	23
7.2 Shock Test	23
7.3 Reliability Test	23
8. Mechanical Characteristics	24
8.1 LCM Outline Dimension (Front View)	24
8.2 LCM Outline Dimension (Rear View)	25
9. Shipping and Package	26
9.1 Carton Package	26
9.2 Shipping Package of Palletizing Sequence	26
10. Appendix: EDID Description	27
11. Inspection	30
12. Warranty	30
13. RMA	30



Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.0 2015/06/12	All	First Edition for Customer		



1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentarily. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.



2. General Description

LMTBC156ZMN1 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 FHD, 1920(H) x 1080(V) screen and 16.2M colors (RGB 6-bits+2FRC data driver) with LED backlight driving circuit. All input signals are eDP(Embedded DisplayPort) interface compatible.

LMTBC156ZMN1 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 °C condition:

Items	Unit	Specifications			
Screen Diagonal	[mm]	15.6"			
Active Area	[mm]	344.16 x 193.59			
Pixels H x V		1920 x 3(RGB) x 1080			
Pixel Pitch	[mm]	0.17925 x 0.17925			
Pixel Format		R.G.B. Vertical Stripe			
Display Mode		AHVA, Normally Black			
White Luminance (ILED=50mA) (Note: ILED is LED current)	[cd/m ²]	400 typ. (Center) 320 min. (Center)			
Contrast Ratio		800:1 (Typ.)			
Response Time	[ms]	25 (Typ.)			
Nominal Input Voltage VDD	[Volt]	+3.3 (Typ.)			
LCD Power Consumption	[Watt]	11.6 (Max., Include Logic and Blu power)			
LED Power Consumption	[Watt]				
Weight	[Grams]	940g(typ),1035(max)			
Physical Size Include bracket	[mm]		Min.	Typ.	Max.
		Length	363.3	363.8	364.3
		Width	215.4	215.9	216.4
		Thickness		9.3	9.8
Electrical Interface		2 Lane eDP			
Glass Thickness	[mm]	0.5			
Surface Treatment		Anti-glare, 3H			
Support Color		16.2M colors (RGB 6-bits+2FRC)			
Temperature Range					
Operating	[°C]	0 to +50.....(0 to +60: TBD)			
Storage (Non-Operating)	[°C]	-20 to +60			



2.2 Optical Characteristics

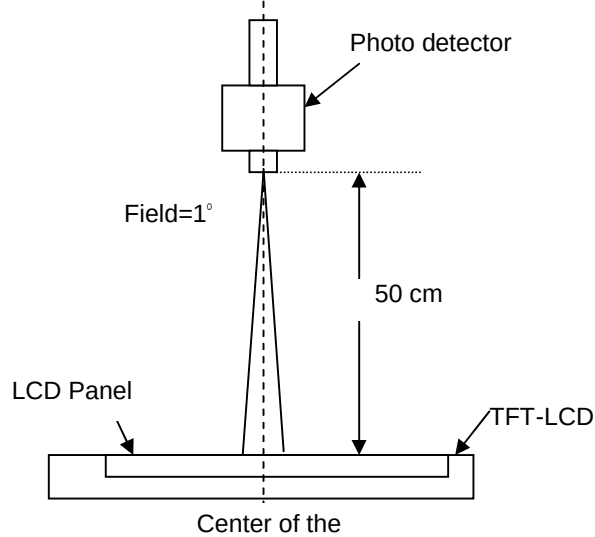
The optical characteristics are measured under stable conditions at 25°C (Room Temperature) :

Item		Unit	Conditions	Min.	Typ.	Max.	Note
White Luminance ILED=50mA		cd/m²	Center average	320	400	-	1, 2
Viewing Angle		degree	Horizontal (Right) CR = 10 (Left)	80	85	-	1, 7
				80	85	-	
			Vertical (Upper) CR = 10 (Lower)	80	85	-	
				80	85	-	
Luminance Uniformity			9 Points	75	80		1, 2, 3
Contrast Ratio				-	800	-	1, 4
Cross talk						4	1, 5
Response Time		msec	Rising + Falling	-	25	35	1, 6
Color / Chromaticity Coordinates	Red	Rx	CIE 1931	0.595	0.645	0.695	4
		Ry		0.285	0.335	0.385	
	Green	Gx		0.263	0.313	0.363	
		Gy		0.564	0.614	0.664	
		Bx		0.102	0.152	0.202	
	Blue	By		0.010	0.060	0.110	
		Wx		0.263	0.313	0.363	
	White	Wy		0.279	0.329	0.379	
	NTSC			%		-	

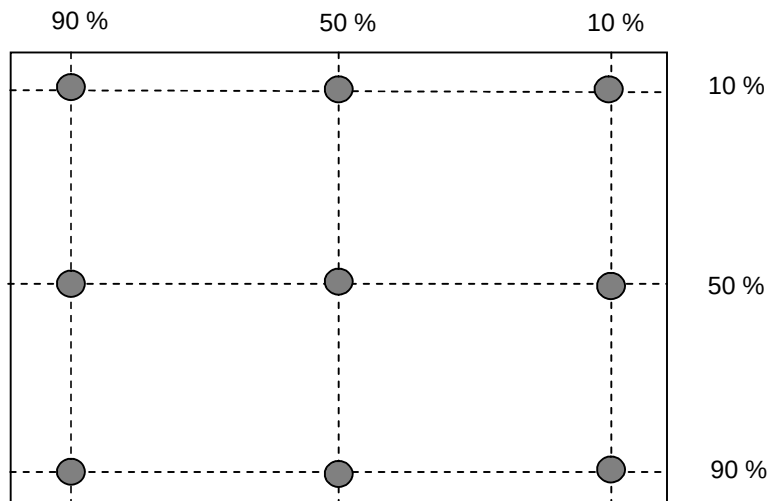


Note 1: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room.



Note 2: 9 points position



Note 3: The luminance uniformity of 9 points is defined by dividing the maximum luminance values by the minimum test point luminance. And measured by TOPCON SR-3

$$\delta_{w9} = \frac{\text{Minimum Luminance of 9 points}}{\text{Maximum Luminance of 9 points}}$$



Note 4 : Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$$

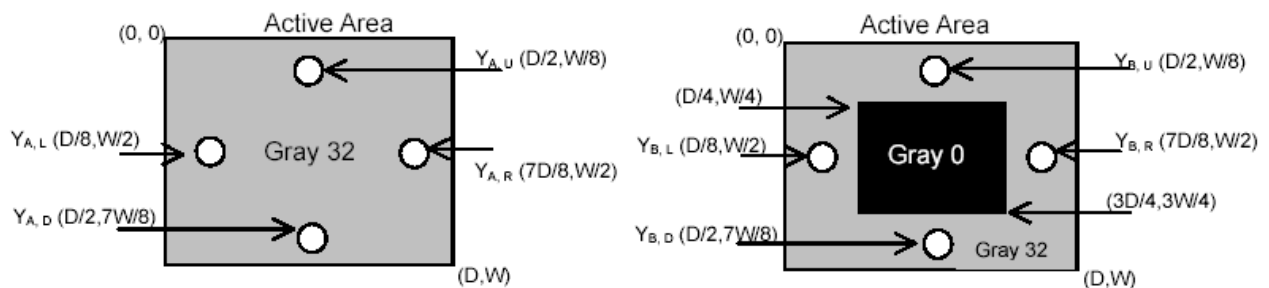
Note 5 : Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

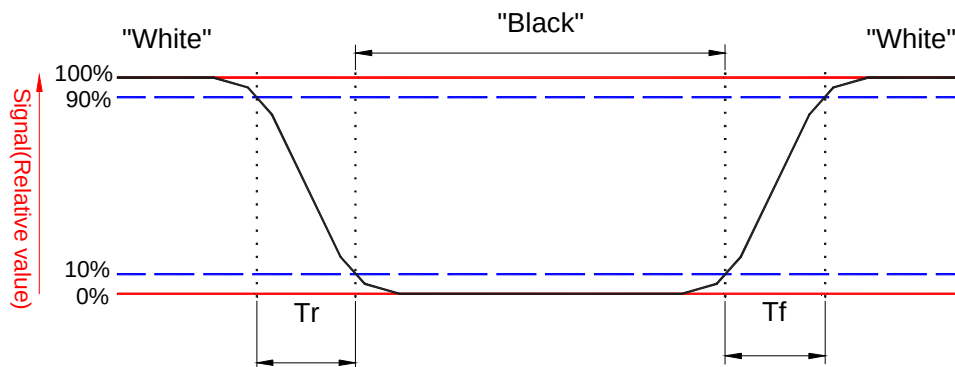
Y_A = Luminance of measured location without gray level 0 pattern (cd/m²)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m²)



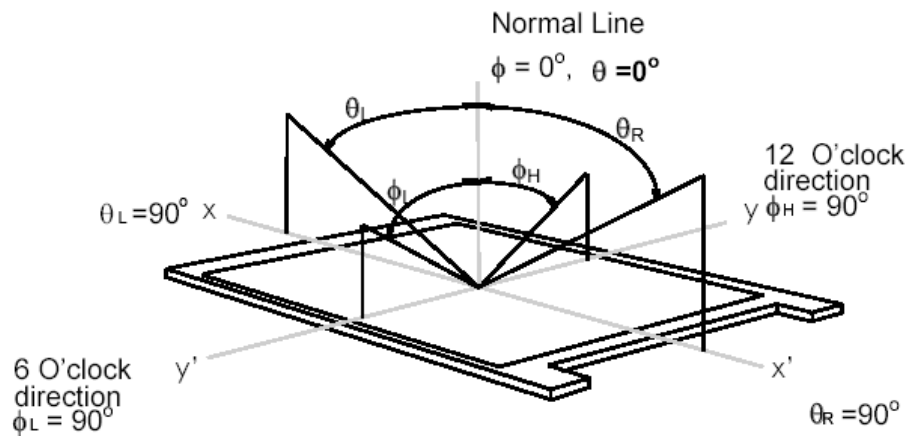
Note 6: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



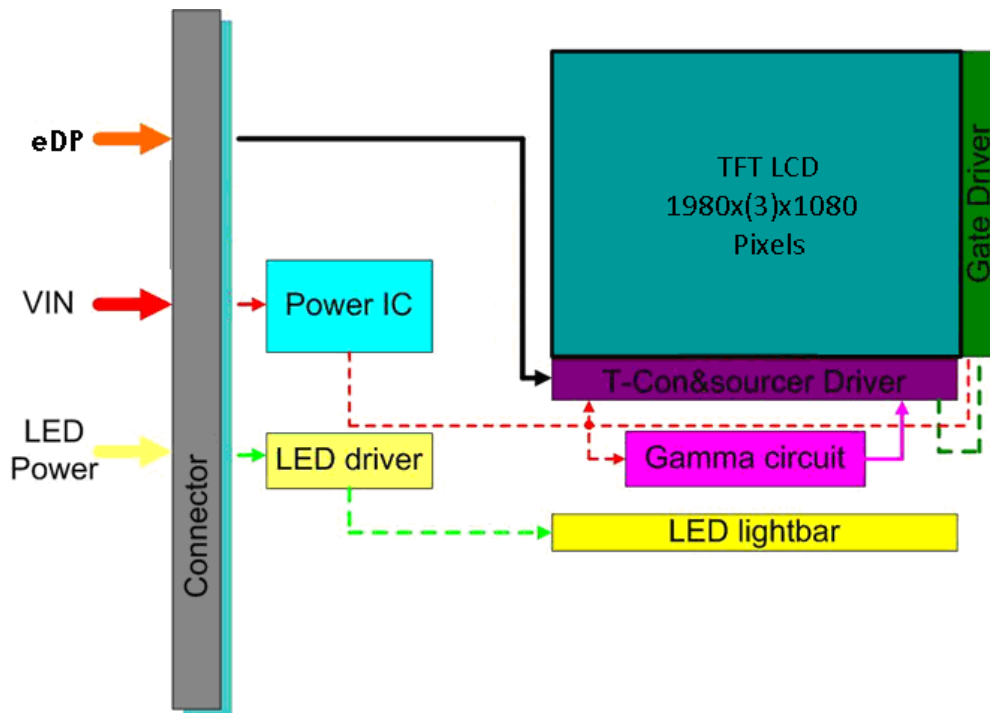
Note 7. Definition of viewing angle

Viewing angle is the measurement of contrast ratio ≥ 10 , at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (ϕ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



3. Functional Block Diagram

The following diagram shows the functional block of the 15.6 inches wide Color TFT/LCD 40 Pin



4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

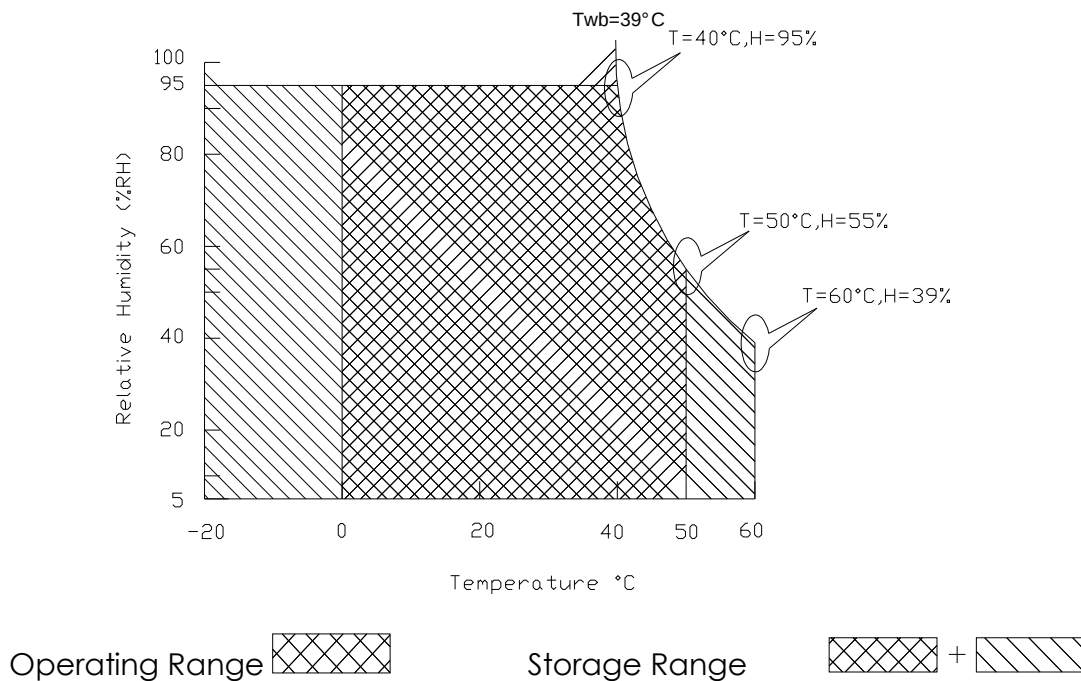
Item	Symbol	Min	Max	Unit	Conditions
Operating	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to IIS(Incoming Inspection Standard).



5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

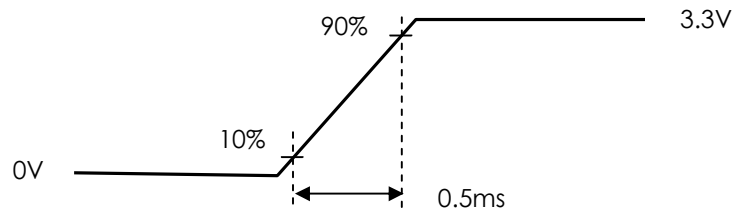
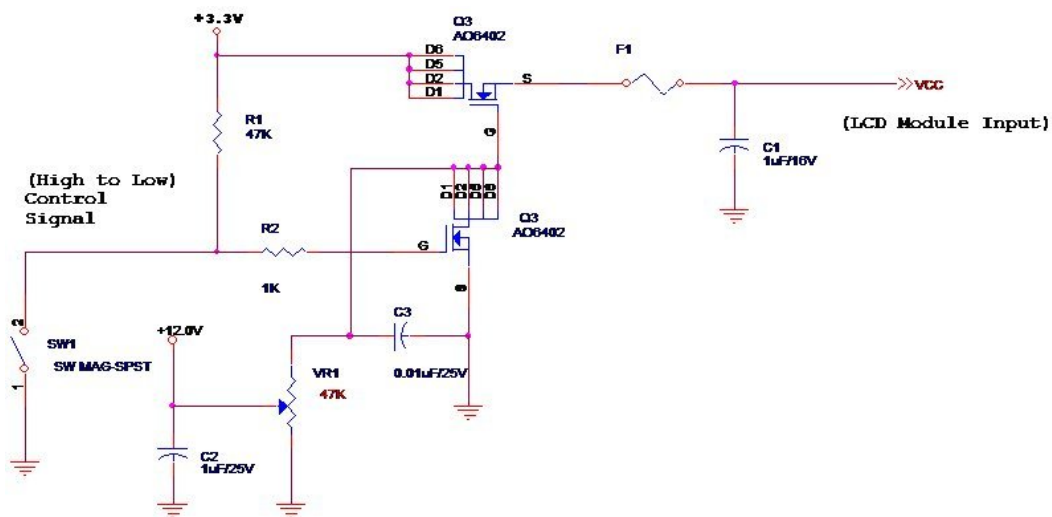
Input power specifications are as follows;

The power specification are measured under 25°C and frame frequency under 60Hz

Symble	Parameter	Min	Typ	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	1.32	1.58	[Watt]	Note 1
IDD	IDD Current	-	400	480	[mA]	Note 1
IRush	Inrush Current	-	-	TBD	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : Black Pattern at 3.3V driving voltage. ($P_{max} = V_{3.3} \times I_{black}$)

Note 2 : Measure Condition



Vin rising time

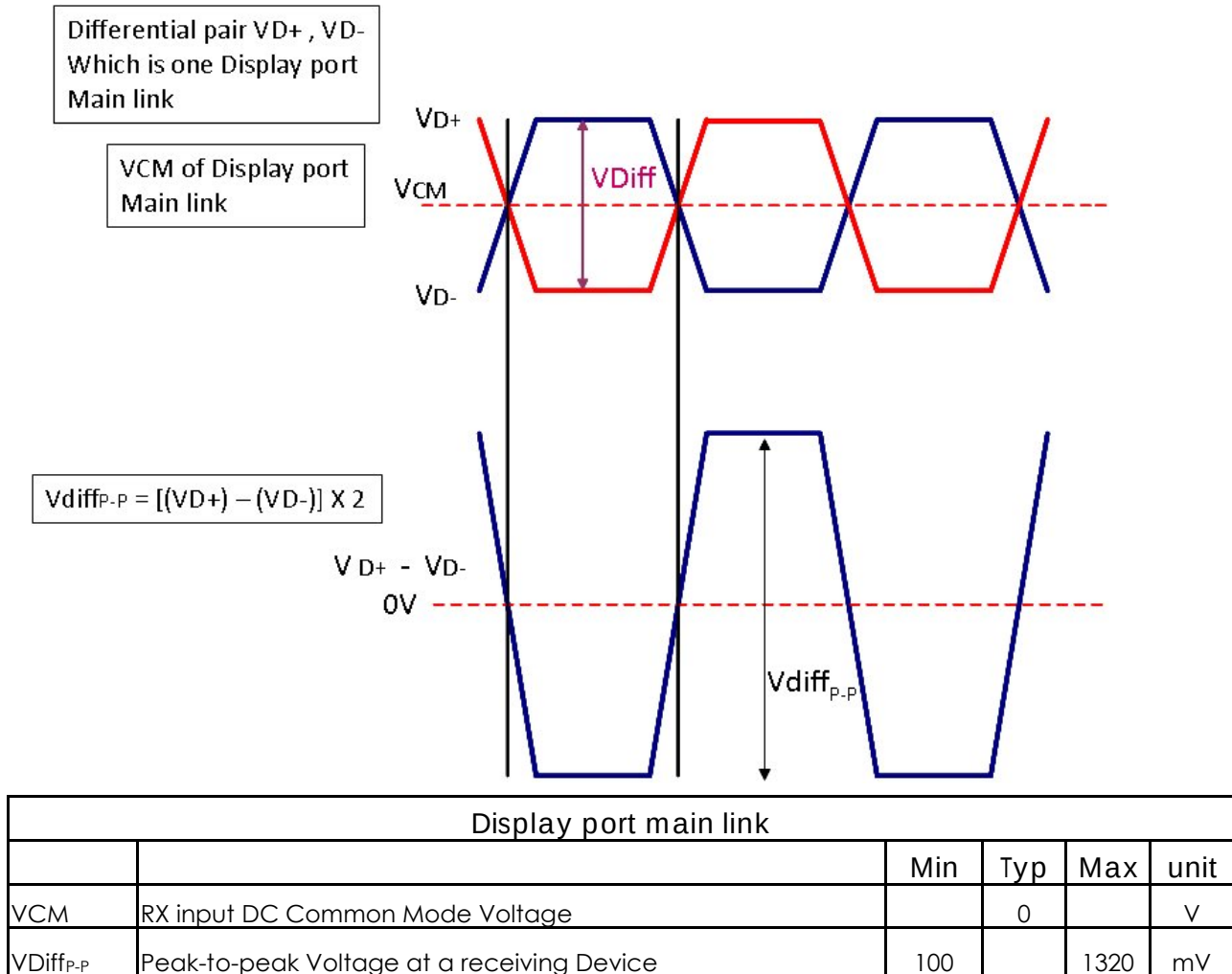


5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

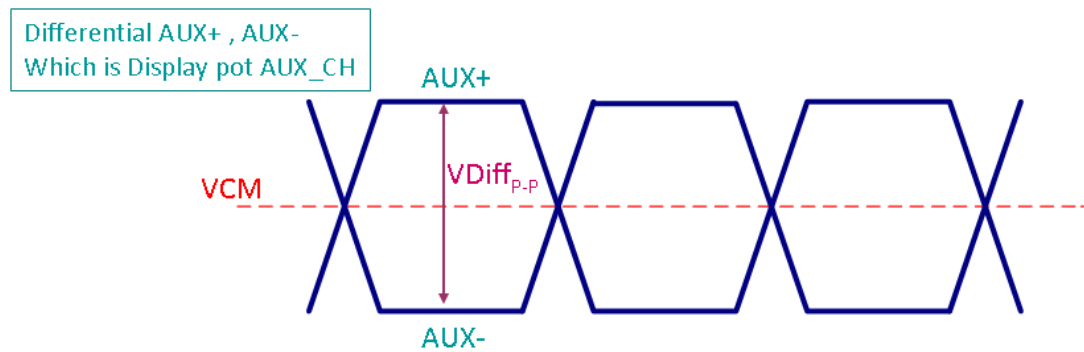
Display Port main link signal:



Fallow as VESA display port standard V1.1a



Display Port AUX_CH signal:



Display port AUX_CH					
		Min	Typ	Max	unit
VCM	AUX DC Common Mode Voltage		0		V
VDiff _{P-P}	AUX Peak-to-peak Voltage at a receiving Device	0.4	0.6	0.8	V

Fallow as VESA display port standard V1.1a.

Display Port VHPD signal:

Display port VHPD					
		Min	Typ	Max	unit
VHPD	HPD Voltage	2.25		3.6	V

Fallow as VESA display port standard V1.1a.



5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Typ	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	8.1	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	50,000	-	-	Hour	(Ta=25°C), Note 2,3

Note 1: Ta means ambient temperature of TFT-LCD module.

Note 2: If G156HAN01.0 module is driven at high ambient temperature & humidity condition. The operating life will be reduced.

Note 3: Operating life means brightness goes down to 50% initial brightness. Min. operating life time is estimated data.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Typ	Max	Units	Remark
LED Power Supply	VLED	10.8	12	13.2	[Volt]	Define as Connector Interface (Ta=25°C)
LED Enable Input High Level	VLED_EN	1.5		5.5	[Volt]	
LED Enable Input Low Level		0		0.9	[Volt]	
PWM Logic Input High Level	VPWM_EN	1.5		5.5	[Volt]	
PWM Logic Input Low Level		0		0.9	[Volt]	
PWM Input Frequency	FPWM	200		15K	Hz	
PWM Duty Ratio	Duty	10		100	%	

Note 1 : Recommended system pull up/down resistor no bigger than 10kohm.

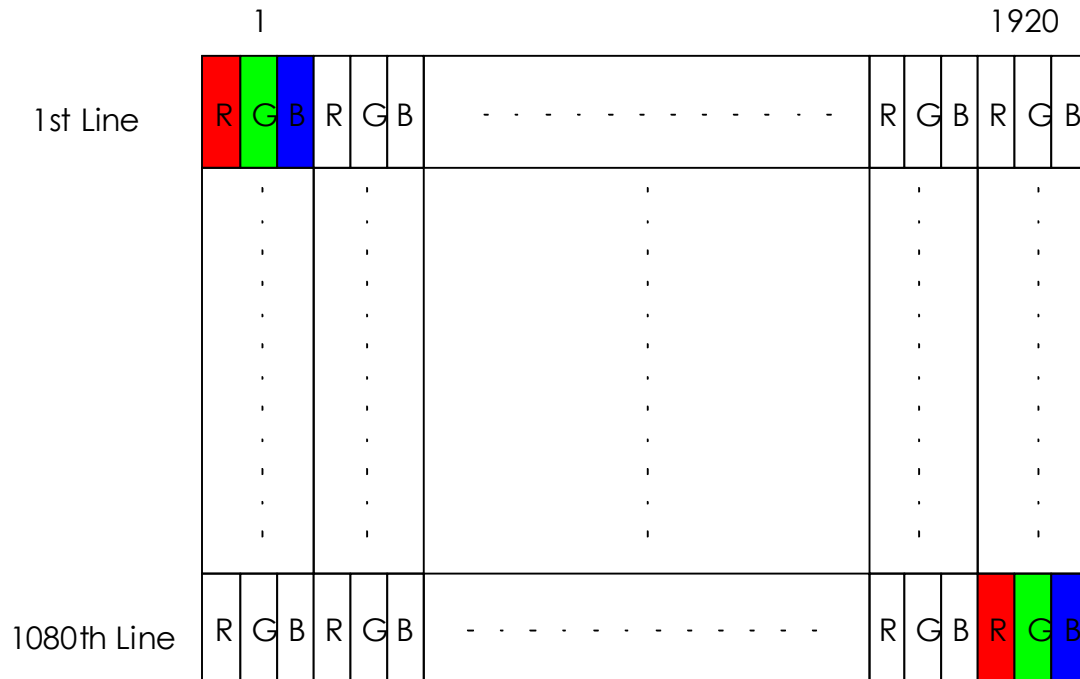
Note 2 : If the PWM duty ratio(min) is set between 5% to 1%, the PWM input frequency should be set below 1KHz . The brightness-duty characteristic might not be able to keep in it's linearity if the dimming control is operated in 1% to 5% range.



6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.



6.2 Integration Interface Requirement

6.2.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	IPEX 20455-040E-12R or compatible
Mating Housing/Part Number	IPEX 20453-040E-12 or compatible



6.2.2 Pin Assignment (2 Lane)

eDP lane is a differential signal technology for LCD interface and high speed data transfer device.

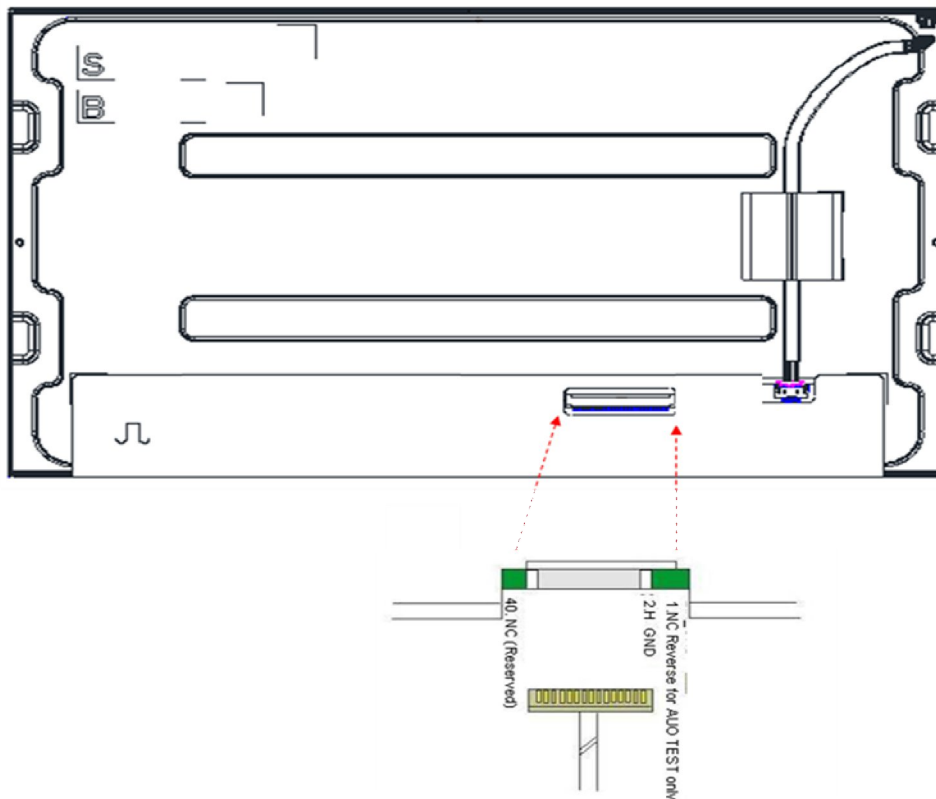
PIN NO	Symbol	Function
1	NC	Reverse for TEST only
2	H_GND	High Speed Ground
3	Lane1_N	Comp Signal Lane 1
4	Lane1_P	True Signal Link Lane 1
5	H_GND	High Speed Ground
6	Lane0_N	Comp Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	H_GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H_GND	High Speed Ground
12	LCD_VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	LCD_Self_Test or NC	LCD Panel Self Test Enable (Optional)
15	LCD_GND	LCD logic and driver ground
16	LCD_GND	LCD logic and driver ground
17	HPD	HPD signal pin
18	BL_GND	Backlight_ground
19	BL_GND	Backlight_ground
20	BL_GND	Backlight_ground
21	BL_GND	Backlight_ground
22	BL_Enable	Backlight On / Off
23	BL_PWM_DIM	System PWM signal Input
24	NC	Reverse for TEST only
25	NC	Reverse for TEST only
26	BL_PWR	Backlight power (5V~21V)
27	BL_PWR	Backlight power (5V~21V)
28	BL_PWR	Backlight power (5V~21V)
29	BL_PWR	Backlight power (5V~21V)
30	NC	No Connect (Reserved for CM)
31	NC	No Connect (Reserved)
32	NC	No Connect (Reserved)
33	NC	No Connect (Reserved)
34	NC	No Connect (Reserved)
35	NC	No Connect (Reserved)
36	NC	No Connect (Reserved)
37	NC	No Connect (Reserved)
38	NC	No Connect (Reserved)
39	NC	No Connect (Reserved)
40	NC	No Connect (Reserved)

Note1 : start from right side

Note2 : Input signals shall be low or High-impedance state when VDD is off.



Note3: Connector Illustration



6.3 Interface Timing

6.3.1 Timing Characteristics

Basically, interface timings should match the 1920x1080 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Typ.	Max.	Unit
Frame Rate		-	-	60	-	Hz
Clock frequency		1/ T _{Clock}	-	141	-	MHz
Vertical Section	Period	T _V	1090	1116	3080	T _{Line}
	Active	T _{VD}	1080			
	Blanking	T _{VB}	10	36	2000	
Horizontal Section	Period	T _H	2000	2104	2320	T _{Clock}
	Active	T _{HD}	1920			
	Blanking	T _{HB}	80	184	400	

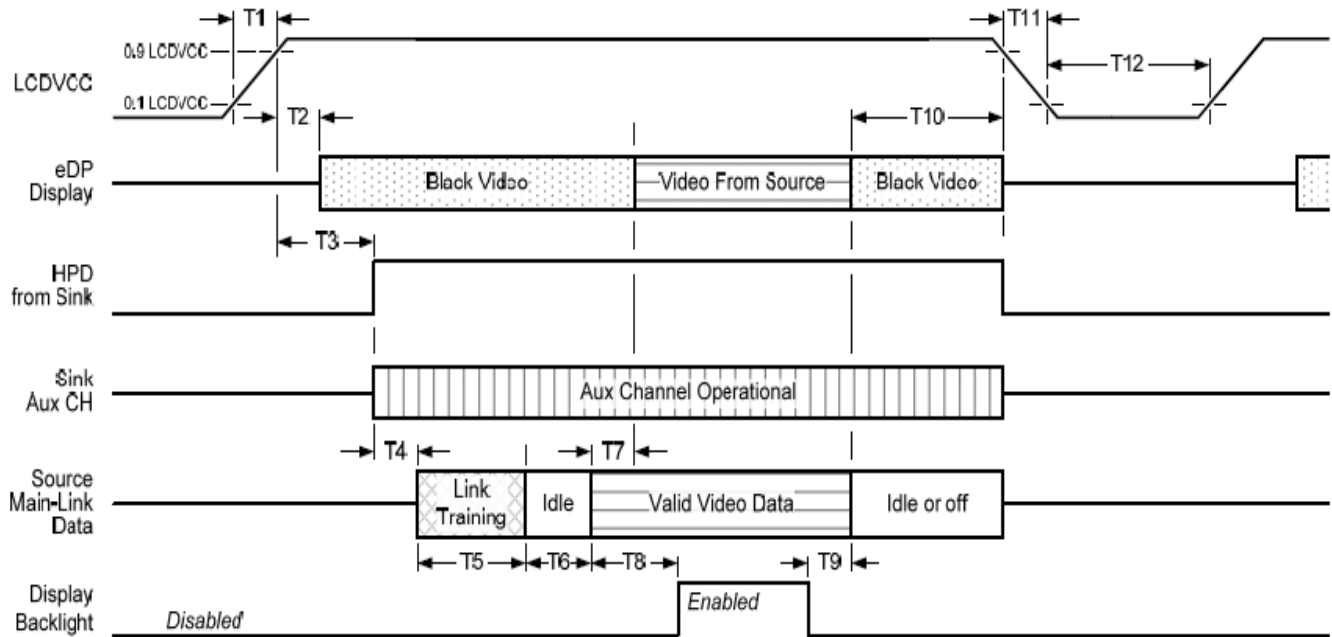
Note 1 : DE mode only

Note 2 : The maximum clock frequency = (960+B)*(1080+A)*60 < 80MHz



6.4 Power ON/OFF Sequence

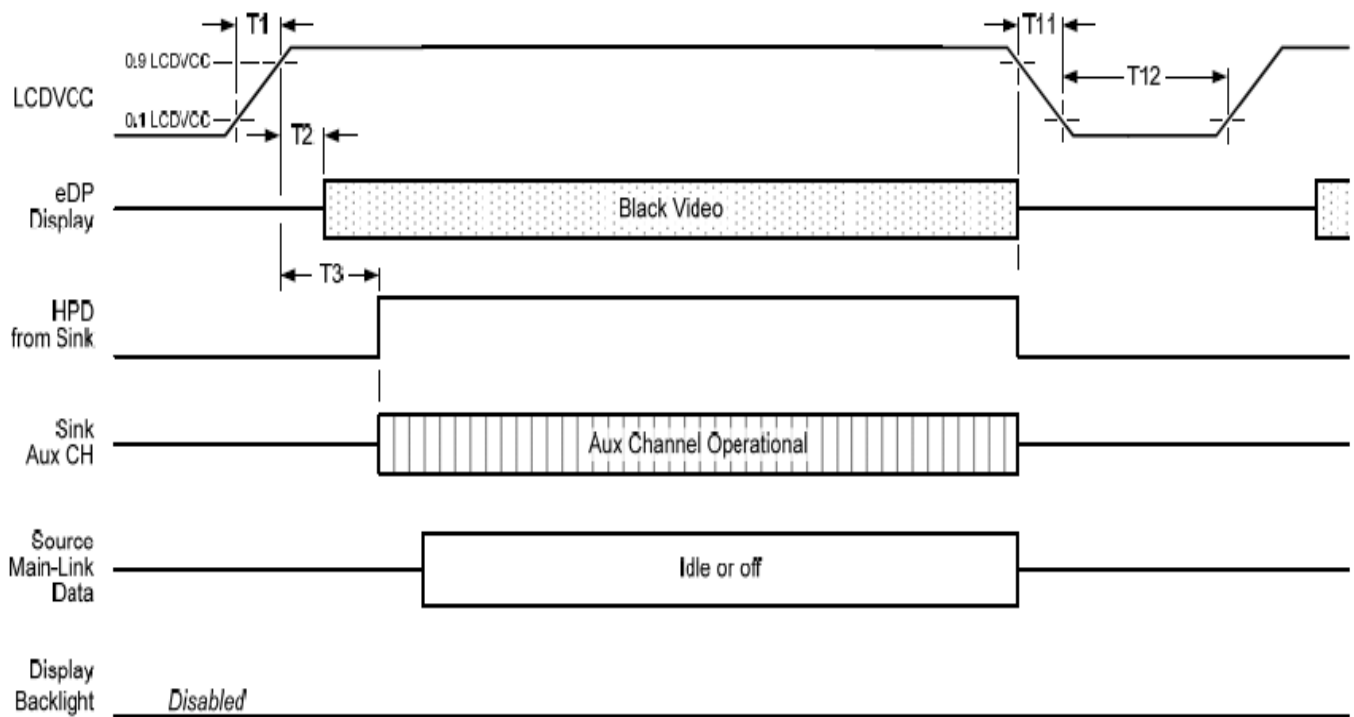
Display Port panel power sequence:



Display port interface power up/down sequence, normal system operation

Display Port AUX_CH transaction only:





Display port interface power up/down sequence, AUX_CH transaction only



Display Port panel power sequence timing parameter:

Timing parameter	Description	Reqd. by	Limits			Notes
			Min.	Typ.	Max.	
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms	
T2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source
T3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.
T4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.
T5	link training duration	source				dependant on source link to read training protocol.
T6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.
T7	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.
T8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.
T9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.
T10	delay from end of valid video data from source to power off	source	0ms		500ms	
T11	power rail fall time, 90% to 10%	source			10ms	
T12	power off time	source	500ms			

Note1: The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

- upon LCDVDD power on (within T2 max)-when the "Novideostream_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).

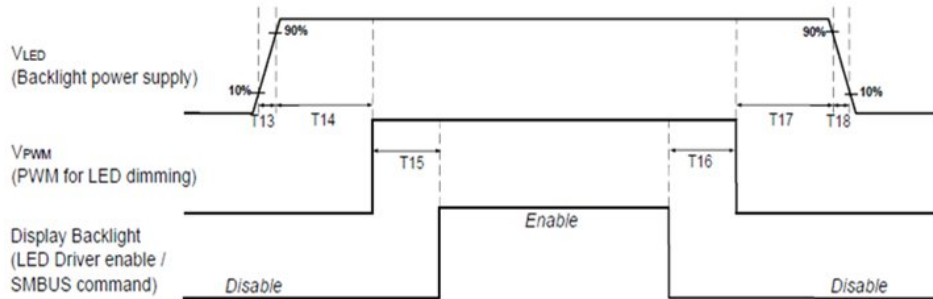
- when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

Note 2: The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

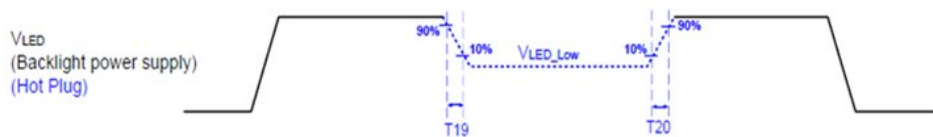
Note 3: The sink must support AUX_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX_CH transaction with the time specified within T3 max.



Display Port panel B/L power sequence timing parameter:



Note : When the adapter is hot plugged, the backlight power supply sequence is shown as below.



	Min (ms)	Max (ms)
T13	0.5	10
T14	10	-
T15	10	-
T16	10	-
T17	10	-
T18	0.5	10
T19	1*	-
T20	1*	-

Seamless change: $T19/T20 = 5 \times T_{PWM}^*$

* $T_{PWM} = 1/PWM \text{ Frequency}$



7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 1.5 G
- Frequency: 10 - 200Hz Random
- Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 50 G , Half sine wave
- Active time: 20 ms
- Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 50°C, 80%RH, 300h	Note 1,2
High Temperature Operation	Ta= 50°C, Dry, 300h	
Low Temperature Operation	Ta= 0°C, 300h	
High Temperature Storage	Ta= 60°C, 300h	
Low Temperature Storage	Ta= -20°C, 300h	
Thermal Shock Test	Ta= -20°C to 60°C, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note 1: According to EN 61000-4-2 , ESD class B: Some performance degradation allowed. Self-recoverable.
No data lost, No hardware failures.

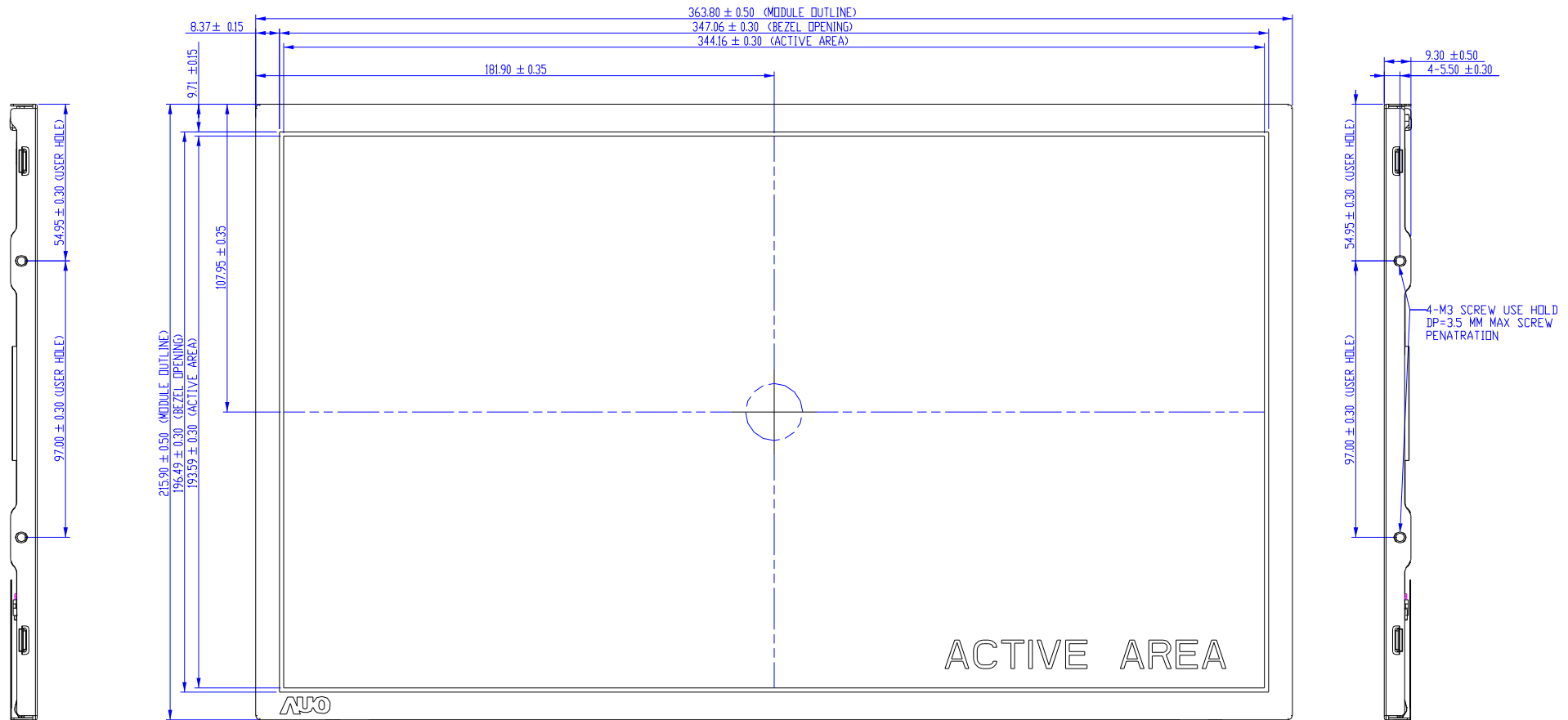
Note 2:

- Water condensation is not allowed for each test items.
- Each test is done by new TFT-LCD module. Don't use the same TFT-LCD module repeatedly for reliability test.
- The reliability test is performed only to examine the TFT-LCD module capability.
- To inspect TFT-LCD module after reliability test, please store it at room temperature and room humidity for 24 hours at least in advance.
- No function failure occurs. Mura shall be ignored after high temperature reliability test

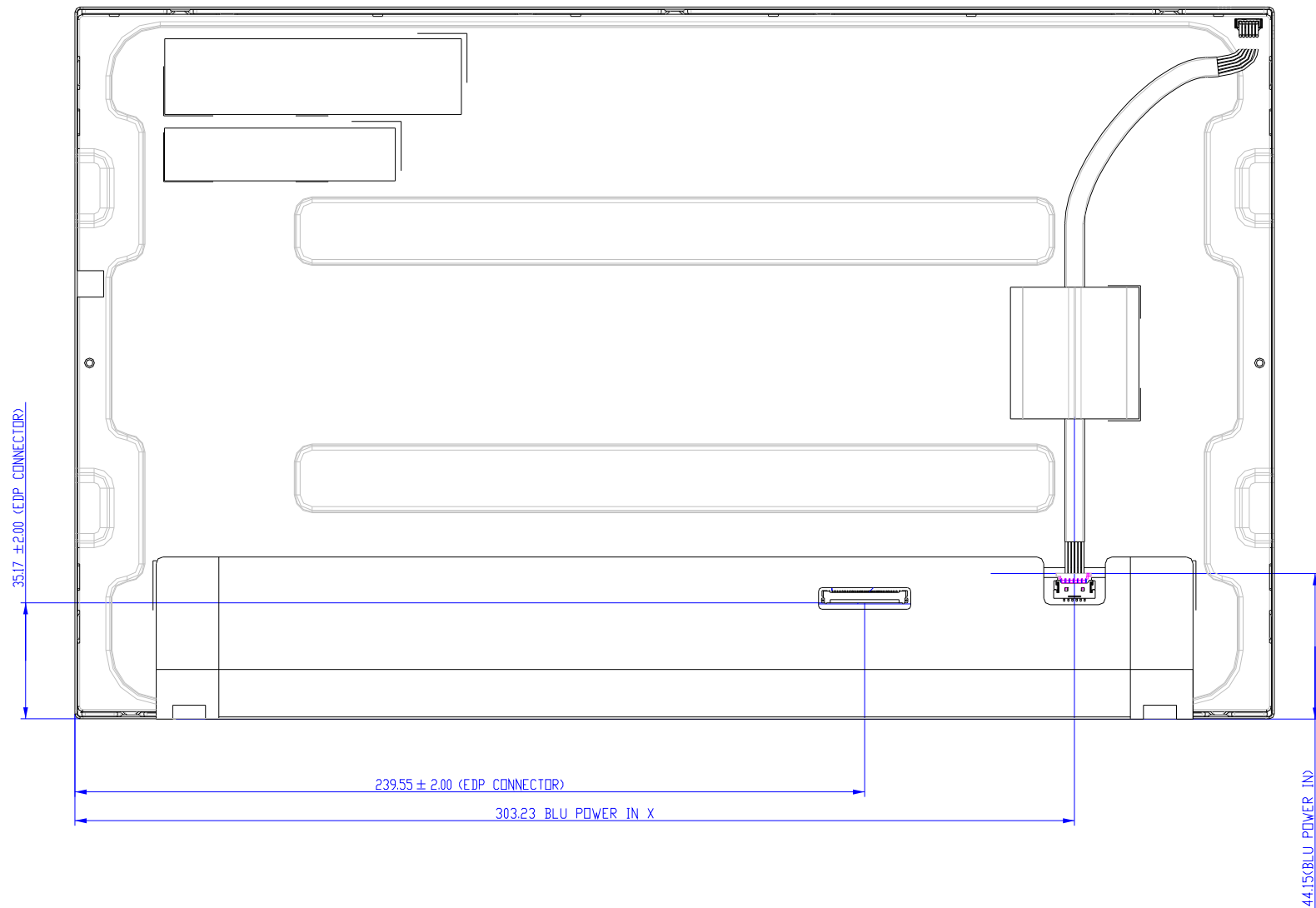


8. Mechanical Characteristics

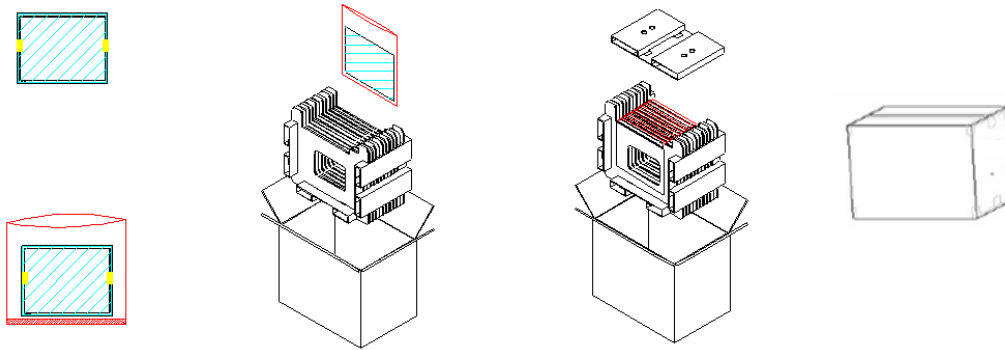
8.1 LCM Outline Dimension (Front View)



8.2 LCM Outline Dimension (Rear View)



9.1 Carton Package



Max capacity : 16 TFT-LCD module per carton

Max weight: 16.3 kg per carton

Outside dimension of carton: 450mm(L)*375mm(W)*319mm(H)

Pallet size : 1150 mm * 910 mm * 132mm

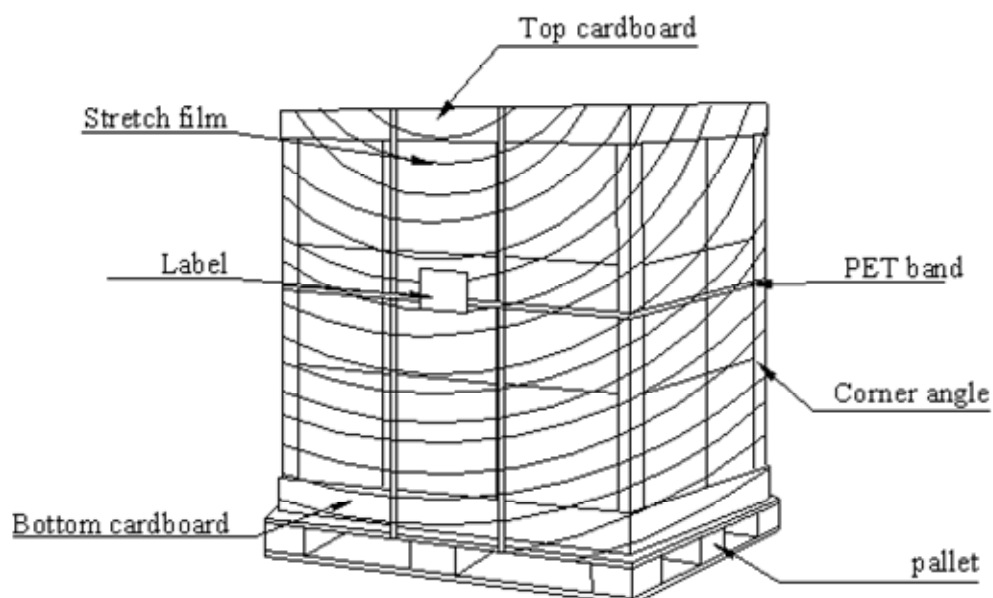
Box stacked

Module by air : (2 *3) *4 layers, one pallet put 24 boxes, total 384pcs module

Module by sea : (2 *3) *4 layers+(2 *3) *1 layers, two pallet put 30 boxes, total 480pcs module

Module by sea_HQ : (2 *3) *4 layers+(2 *3) *2 layers, two pallet put 42 boxes, total 576 pcs module

9.2 Shipping Package of Palletizing Sequence



10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	ED	11101101	237	
0B	hex, LSB first	30	00110000	48	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	21	00100001	33	
11	Year of manufacture	17	00010111	23	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	95	10010101	149	
15	Max H image size (rounded to cm)	22	00100010	34	
16	Max V image size (rounded to cm)	13	00010011	19	
17	Display Gamma (=gamma*100)-100	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	E2	11100010	226	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	95	10010101	149	
1B	Red x (Upper 8 bits)	A3	10100011	163	
1C	Red y/ highER 8 bits	54	01010100	84	
1D	Green x	52	01010010	82	
1E	Green y	99	10011001	153	
1F	Blue x	26	00100110	38	
20	Blue y	0F	00001111	15	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	



28	Standard timing #2	01	00000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	14	00010100	20	
37	Pixel Clock/10000 USB	37	00110111	55	
38	Horz active Lower 8bits	80	10000000	128	
39	Horz blanking Lower 8bits	B8	10111000	184	
3A	HorzAct:HorzBlink Upper 4:4 bits	70	01110000	112	
3B	Vertical Active Lower 8bits	38	00111000	56	
3C	Vertical Blanking Lower 8bits	24	00100100	36	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	40	01000000	64	
3E	HorzSync. Offset	10	00010000	16	
3F	HorzSync.Width	10	00010000	16	
40	VertSync.Offset : VertSync.Width	3E	00111110	62	
41	Horz&Vert Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	58	01011000	88	
43	Vertical Image Size Lower 8bits	C1	11000001	193	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	B8	10111000	184	
49	descriptor #2	24	00100100	36	
4A		80	10000000	128	
4B		B8	10111000	184	
4C		70	01110000	112	
4D		38	00111000	56	
4E		24	00100100	36	
4F		40	01000000	64	
50		10	00010000	16	
51		10	00010000	16	
52		3E	00111110	62	
53		00	00000000	0	



54		58	01011000	88	
55		C1	11000001	193	
56		10	00010000	16	
57		00	00000000	0	
58		00	00000000	0	
59		18	00011000	24	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	A
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	O
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	B
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	35	00110101	53	5
74	Manufacture P/N	36	00110110	54	6
75	Manufacture P/N	48	01001000	72	H
76	Manufacture P/N	41	01000001	65	A
77	Manufacture P/N	4E	01001110	78	N
78	Manufacture P/N	30	00110000	48	0
79	Manufacture P/N	33	00110011	51	3
7A	Manufacture P/N	2E	00101110	46	.
7B	Manufacture P/N	30	00110000	48	0
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	D9	11011001	217	



11 .Inspection Specifications

The buyer (customer) shall inspect the modules within twenty calendar days since the delivery date (the "inspection period") at its own cost. The results of the inspection (acceptance or rejection) shall be recorded in writing, and a copy of this writing will be promptly sent to the seller.

The buyer may, under commercially reasonable reject procedures, reject an entire lot in the delivery involved if, within the inspection period, such samples of modules within such lot show an unacceptable number of defects in accordance with this incoming inspection standards, provided however that the buyer must notify the seller in writing of any such rejection promptly, and not later than within three business days of the end of the inspection period.

Should the buyer fail to notify the seller within the inspection period, the buyer's right to reject the modules shall be lapsed and the modules shall be deemed to have been accepted by the buyer.

12. Warranty

Inteltronic Inc. warrants to you, the original purchaser, that each of its products will be free from defects in materials and workmanship for one year from the date of purchase.

Inteltronic Inc. will be limited to replace or repair any of its module which is found and confirmed defective electrically or visually when inspected in accordance with Inteltronic Inc. general module inspection standard.

This warranty does not apply to any products which have been on customer's production line, repaired or altered by persons other than repair personnel authorized by Inteltronic Inc., or which have been subject to misuse, abuse, accident or improper installation. Inteltronic Inc. assumes no liability under the terms of this warranty as a consequence of such events.

If an Inteltronic Inc. product is defective, it will be repaired or replaced at no charge during the warranty period. For out-of-warranty repairs, you will be billed according to the cost of replacement materials, service time and freight. In returning the modules, they must be properly packaged with original package; there should be detailed description of the failures or defect.

13. RMA

Products purchased through Inteltronic Inc. and under warranty may be returned for replacement. Contact support@inteltronicinc.com for RMA number and procedures



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